PNP Transistor with Dual Series Switching Diode

Features

 These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- LCD Control Board
- High Speed Switching
- High Voltage Switching

MAXIMUM RATINGS - PNP TRANSISTOR

Rating	Symbol	Value	Unit
Collector - Emitter Voltage	V _{CEO}	-80	Vdc
Collector - Base Voltage	V _{CBO}	-80	Vdc
Emitter - Base Voltage	V _{EBO}	-4.0	Vdc
Collector Current - Continuous	Ic	-500	mAdc

MAXIMUM RATINGS - SWITCHING DIODE

Rating	Symbol	Value	Unit
Reverse Voltage	V_R	100	V
Forward Current	lF	200	mA
Non-Repetitive Peak Forward Current (Square Wave, T_J = 25°C prior to surge) $t < 1$ sec $t = 1$ µsec	I _{FSM}	1.0 20	Α
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

ESD RATINGS

Rating		Class	Value
Electrostatic Discharge	HBM	3A	4000 V ≤ Failure < 8000 V
	MM	M4	Failure > 400 V

THERMAL CHARACTERISTICS

Rating	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) @ T _A = 25°C Derate above 25°C	P _D	400	mW mW/°C
Thermal Resistance from Junction–to–Ambient (Note 1)	$R_{\theta JA}$	313	°C/W
Total Device Dissipation FR-5 Board (Note 2) T _A = 25°C Derate above 25°C	P _D	270	mW mW/°C
Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{\theta JA}$	463	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C

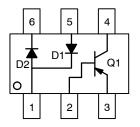
- 1. $FR-5 = 650 \text{ mm}^2 \text{ pad}$, 2.0 oz Cu.
- 2. $FR-5 = 10 \text{ mm}^2 \text{ pad}, 2.0 \text{ oz Cu}.$



ON Semiconductor®

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PNP Transistor with Dual Series Switching Diode





SC-74 CASE 318F

MARKING DIAGRAM



3PN = Device Code M = Date Code* ■ Pb-Free Package

(Note: Microdot may be in either location)
*Date Code orientation may vary depending upon manufacturing location.

ORDERING INFORMATION

Device	Package	Shipping [†]
NSM80100MT1G	SC-74 (Pb-Free)	3000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

Q1: PNP TRANSISTOR ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector - Emitter Breakdown Voltage (Note 3)	$(I_C = -1.0 \text{ mA}, I_B = 0)$	V _{(BR)CEO}	-80	-	V
Emitter - Base Breakdown Voltage	$(I_E = -100 \mu A, I_C = 0)$	V _{(BR)EBO}	-4.0	_	V
Collector Cutoff Current	(V _{CE} = -60 V, I _B = 0)	I _{CES}	-	-0.1	μΑ
Collector Cutoff Current	(V _{CB} = -80 V, I _E = 0)	I _{CBO}	-	-0.1	μΑ
ON CHARACTERISTICS (Note 3)					
DC Current Gain	(I _C = -10 mA, V _{CE} = -1.0 V)	h _{FE}	120	_	-
Collector - Emitter Saturation Voltage	(I _C = -100 mA, I _B = -10 mA)	V _{CE(sat)}	-	-0.25	V
Base - Emitter Saturation Voltage	(I _C = -100 mA, V _{CE} = -1.0 V)	V _{BE(sat)}	-	-1.2	V
SMALL-SIGNAL CHARACTERISTICS					
Current – Gain – Bandwidth Product (Note 4) (I _C = -100	mA, V _{CE} = -2.0 V, f = 100 MHz)	f _T	150	_	MHz

D1, D2: SWITCHING DIODE (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			•	
Reverse Breakdown Voltage	V _(BR)	75	_	V
Reverse Voltage Leakage Current $ \begin{pmatrix} V_R = 75 \ V \end{pmatrix} \\ (V_R = 20 \ V, T_J = 150^\circ C) \\ (V_R = 75 \ V, T_J = 150^\circ C) \end{pmatrix} $	I _R	- - -	1.0 30 100	μΑ
Diode Capacitance $(V_{R}=0\;V,f=1.0\;MHz)$	C _D	_	1.5	pF
Forward Voltage $\begin{array}{c} (I_F=1.0\text{ mA})\\ (I_F=10\text{ mA})\\ (I_F=50\text{ mA})\\ (I_F=50\text{ mA}) \end{array}$	V _F	- - - -	715 855 1000 1250	mV
Reverse Recovery Time $(I_F=I_R=10~\text{mA},i_{R(REC)}=1.0~\text{mA},R_L=100~\Omega)$	t _{rr}	_	4.0	ns
Forward Recovery Voltage $ (I_{\textrm{F}} = 10 \textrm{ mA}, t_{\textrm{r}} = 20 \textrm{ ns}) $	V _{FR}	-	1.75	V

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.
 fT is defined as the frequency at which |h_{fe}| extrapolates to unity.

TYPICAL CHARACTERISTICS

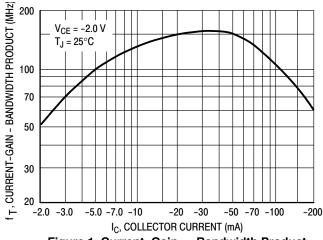


Figure 1. Current-Gain — Bandwidth Product

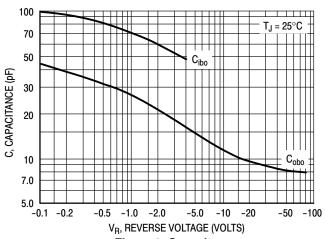


Figure 2. Capacitance

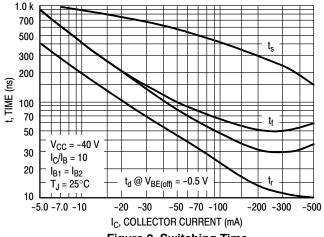


Figure 3. Switching Time

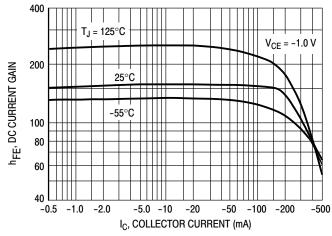


Figure 4. DC Current Gain

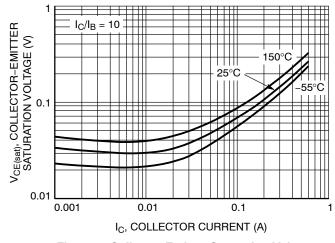


Figure 5. Collector Emitter Saturation Voltage vs. Collector Current

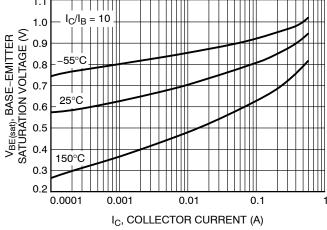


Figure 6. Base Emitter Saturation Voltage vs.
Collector Current

TYPICAL CHARACTERISTICS

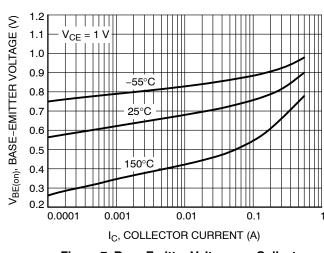


Figure 7. Base Emitter Voltage vs. Collector Current

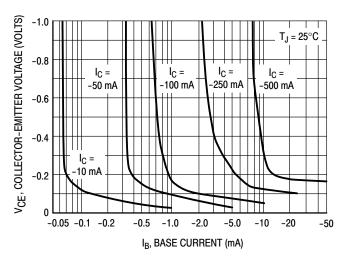


Figure 8. Collector Saturation Region

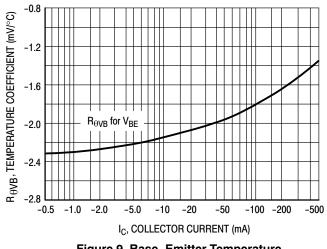


Figure 9. Base-Emitter Temperature Coefficient

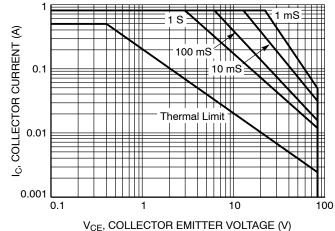


Figure 10. Safe Operating Area

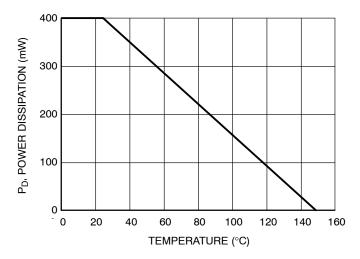
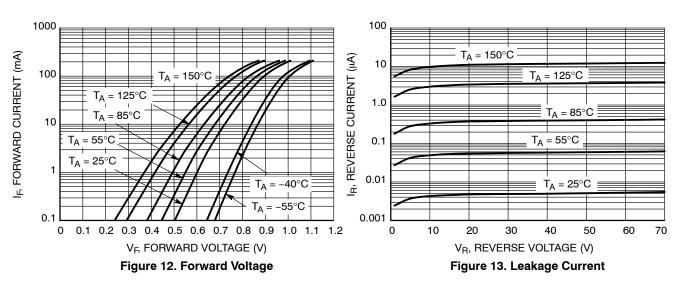


Figure 11. Operating Temperature Derating

TYPICAL CHARACTERISTICS



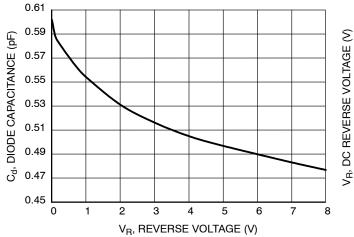


Figure 14. Capacitance

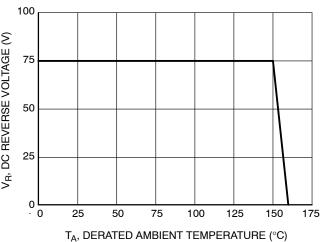


Figure 15. Diode Power Dissipation Curve





CTVLE 4.

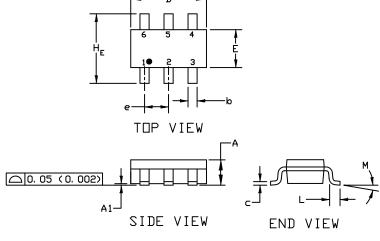
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DATE 07 OCT 2021

NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994
- 2. CONTROLLING DIMENSION: INCHES
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.

	MI	LLIMETER	25		INCHES	
DIM	MIN.	N□M.	MAX.	MIN.	N□M.	MAX.
A	0. 90	1. 00	1. 10	0. 035	0. 039	0. 043
A1	0. 01	0. 06	0. 10	0. 001	0. 002	0. 004
b	0. 25	0. 37	0. 50	0. 010	0. 015	0. 020
С	0.10	0. 18	0. 26	0. 004	0. 007	0. 010
D	2. 90	3. 00	3. 10	0. 114	0. 118	0. 122
E	1. 30	1. 50	1. 70	0. 051	0. 059	0. 067
е	0. 85	0. 95	1. 05	0. 034	0. 037	0. 041
Η _E	2. 50	2. 75	3. 00	0. 099	0. 108	0. 118
L	0. 20	0. 40	0. 60	0. 008	0. 016	0. 024
М	0*		10*	0*		10*



GENERIC MARKING DIAGRAM*



XXX = Specific Device Code

M = Date Code

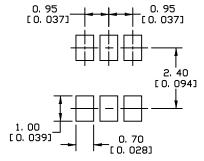
CTVLE O

■ = Pb-Free Package

(Note: Microdot may be in either location)

This information is generic. Please refer to

CTVI F O



For additional information on our Pb-Free strategy and soldering details, please download the UN Seniconductor Soldering and Mounting Techniques Reference Manual, SULDERRM/D.

SOLDERING FOOTPRINT

CTVLE 6

CTVLE F.

STYLE 1:	STYLE 2:	STYLE 3:	STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. CATHODE	PIN 1. NO CONNECTION	PIN 1. EMITTER 1	PIN 1. COLLECTOR 2	PIN 1. CHANNEL 1	PIN 1. CATHODE
2. ANODE	2. COLLECTOR	2. BASE 1	2. EMITTER 1/EMITTER 2	2. ANODE	ANODE
CATHODE	EMITTER	COLLECTOR 2	COLLECTOR 1	CHANNEL 2	CATHODE
CATHODE	NO CONNECTION	EMITTER 2	4. EMITTER 3	CHANNEL 3	CATHODE
5. ANODE	COLLECTOR	5. BASE 2	BASE 1/BASE 2/COLLECTOR 3	CATHODE	CATHODE
CATHODE	6. BASE	COLLECTOR 1	6. BASE 3	CHANNEL 4	CATHODE
STYLE 7: PIN 1. SOURCE 1 2. GATE 1 3. DRAIN 2 4. SOURCE 2 5. GATE 2 6. DRAIN 1	STYLE 8: PIN 1. EMITTER 1 2. BASE 2 3. COLLECTOR 2 4. EMITTER 2 5. BASE 1 6. COLLECTOR 1	STYLE 9: PIN 1. EMITTER 2 2. BASE 2 3. COLLECTOR 1 4. EMITTER 1 5. BASE 1 6. COLLECTOR 2	STYLE 10: PIN 1. ANODE/CATHODE 2. BASE 3. EMITTER 4. COLLECTOR 5. ANODE 6. CATHODE	STYLE 11: PIN 1. EMITTER 2. BASE 3. ANODE/CATHODI 4. ANODE 5. CATHODE 6. COLLECTOR	E

CTVLE 4.

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